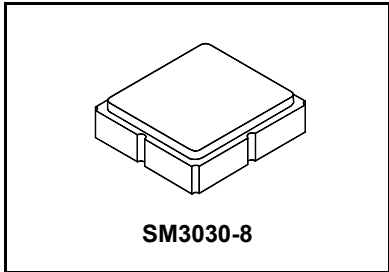


**SF2163E**

**1076.06 MHz  
SAW Filter**



- SAW Filter for Digital Television
- Complies with Directive 2002/95/EC (RoHS)



**Characteristics :**

Balance-to-Balanced Operation

Terminating Source/Load Impedance :  $Z_S = 150 \Omega$

**Maximum Rating**

Rating	Value	Units
Input Power Level	0	dBm
DC Voltage on any Non-ground Terminal	3	V
Operable Temperature Range	-45 to +125	°C
Specification Temperature Range	-40 to +85	°C
Storage Temperature Range in Tape and Reel	-40 to +85	°C
Maximum Soldering Profile, 5 cycles/ 10 seconds maximum	265	°C

**Electrical Characteristics**

Characteristic	Sym	Notes	Min	Typ	Max	Units
Center Frequency	$f_C$			1076.06		MHz
Maximum Insertion Loss, 1056.06 to 1096.06 MHz	$IL_{MAX}$			3.5	5.5	dB
1.5 dB Bandwidth				52		MHz
Amplitude Ripple, 1056.06 to 1096.06 MHz				1.0	2.2	dB
Attenuation, Referenced to $IL_{MAX}$						
50 to 994.04 MHz			45	53		dB
1158.20 to 3150 MHz			40	50		
3150 to 6000 MHz			18	20		
Group Delay Ripple, 1056.06 to 1096.06 MHz				15	40	nSp-p

Case Style	SM3030-8 3.0 x 3.0 mm Nominal Footprint					
Lid Symbolization (Y=year, WW=week, S=shift) dot=pin 1 indicator	859, YWWS					
Standard Reel Quantity	Reel Size 7 Inch					500 Pieces/Reel
	Reel Size 13 Inch					3000 Pieces/Reel

**Electrical Connection**

	Connection	Terminals
Port 1	Balanced Input	1,2
Port 2	Balanced Output	5,6
	Ground	All Others

Dot Indicates Pin 1

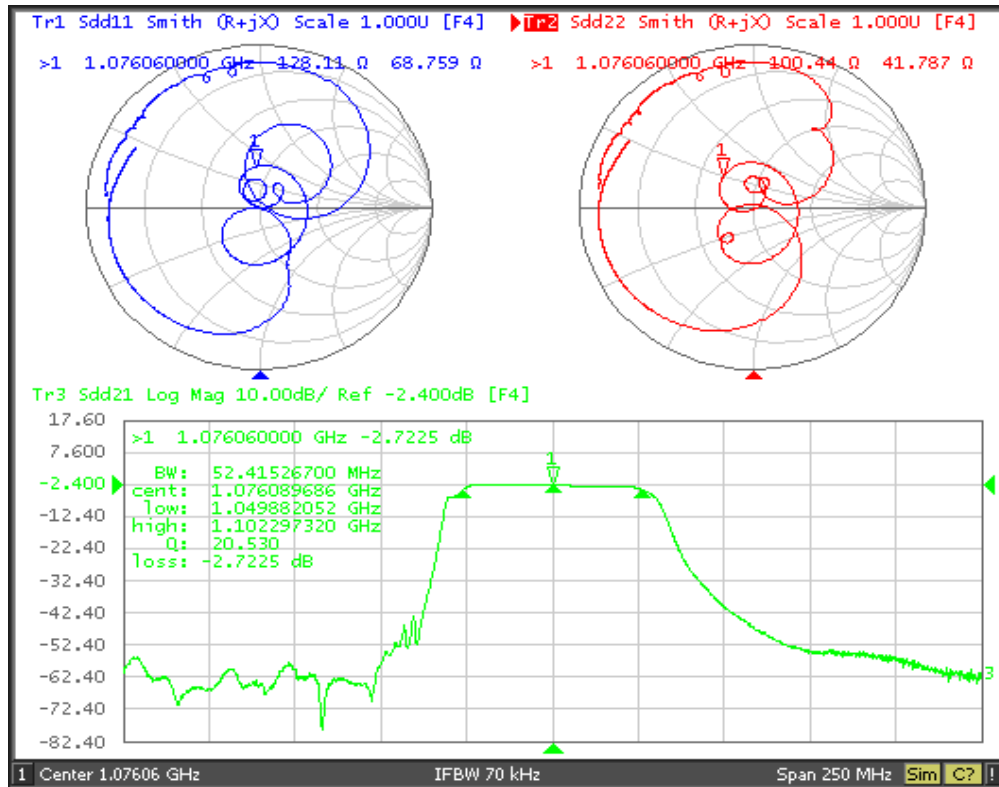


**CAUTION: Electrostatic Sensitive Device. Observe precautions for handling.**

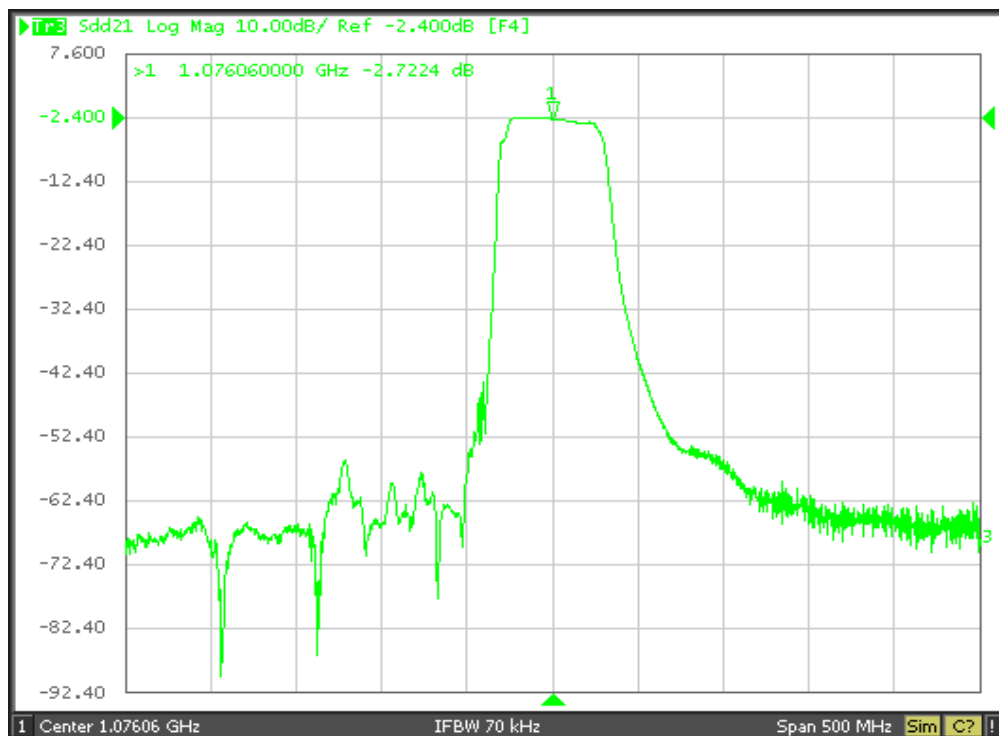
**Notes:**

1. US and international patents may apply.
2. Murata, stylized Murata logo, and Murata N.A., Inc. are registered trademarks of Murata Manufacturing Co., Ltd.

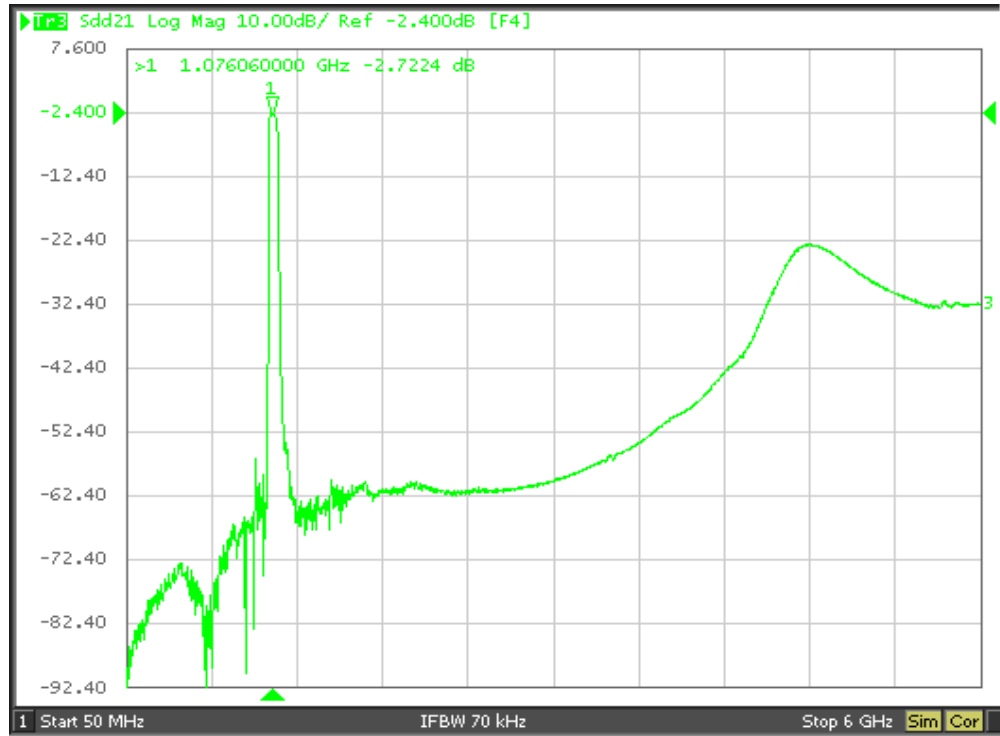
## Filter $S_{11}$ , $S_{22}$ and $S_{21}$ Plots



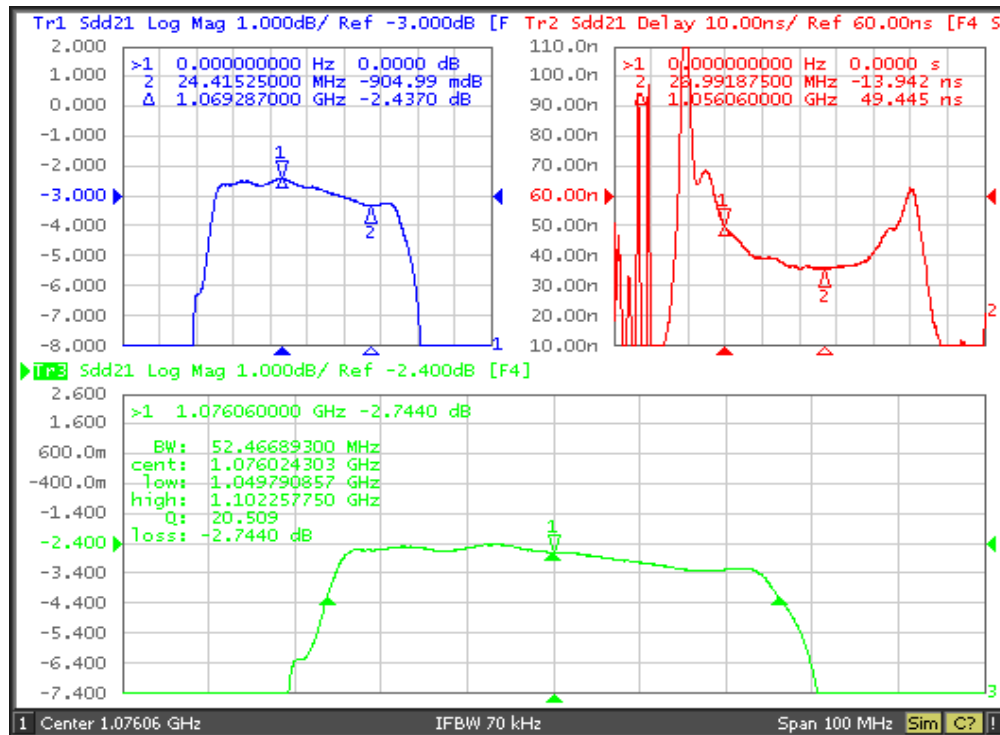
## Filter Near-in Rejection



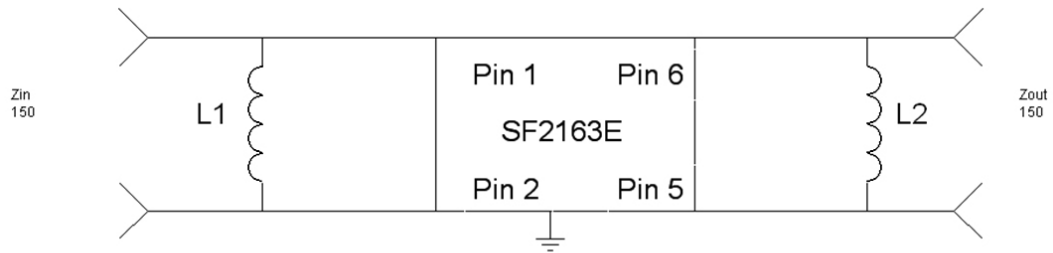
## Filter Broadband Rejection



## Filter Passband Amplitude and Group Delay Detail



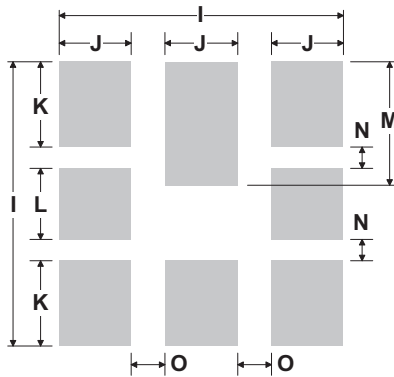
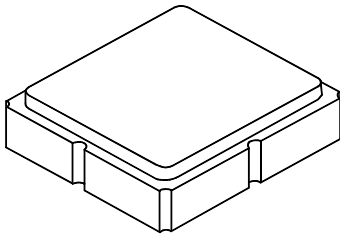
## Tuning Network, 150 ohm Balanced Source/Load



All other pins grounded

**L1**    **22 nH**  
**L2**    **24 nH**

## 8-Terminal Ceramic Surface-Mount Case 3.0 X 3.0 mm Nominal Footprint



**PCB Footprint Top View**

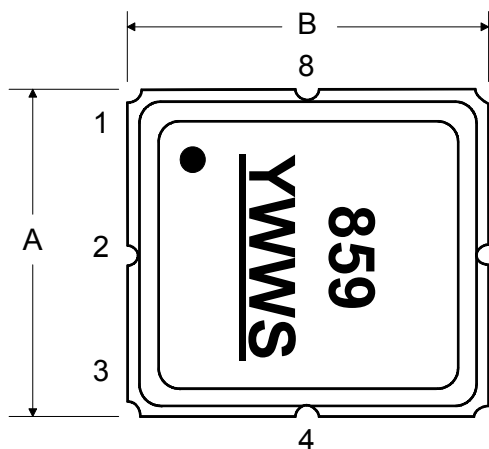
### Case and PCB Footprint Dimensions

Dimension	mm			Inches		
	Min	Nom	Max	Min	Nom	Max
A	2.87	3.0	3.13	0.113	0.118	0.123
B	2.87	3.0	3.13	0.113	0.118	0.123
C	1.14	1.27	1.40	0.045	0.050	0.055
D	0.79	0.92	1.05	0.031	0.036	0.041
E	0.62	0.75	0.88	0.024	0.029	0.034
F	0.47	0.60	0.73	0.018	0.024	0.029
G	0.47	0.60	0.73	0.018	0.024	0.029
H	1.07	1.20	1.33	0.042	0.047	0.052
I		3.19			0.126	
J		0.81			0.032	
K		0.96			0.038	
L		0.81			0.032	
M		1.39			0.055	
N		0.23			0.009	
O		0.38			0.015	

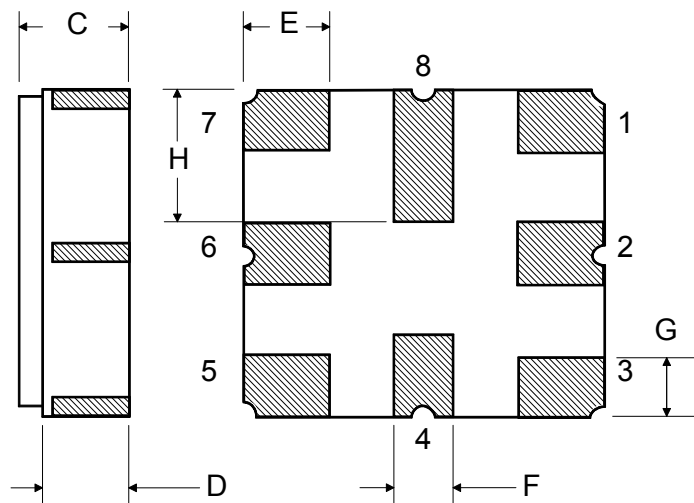
### Case Materials

Materials	
Solder Pad Plating	0.3 to 1.0 $\mu\text{m}$ Gold over 1.27 to 8.89 $\mu\text{m}$ Nickel
Lid Plating	2.0 to 3.0 $\mu\text{m}$ Nickel
Body	$\text{Al}_2\text{O}_3$ Ceramic
	Pb Free

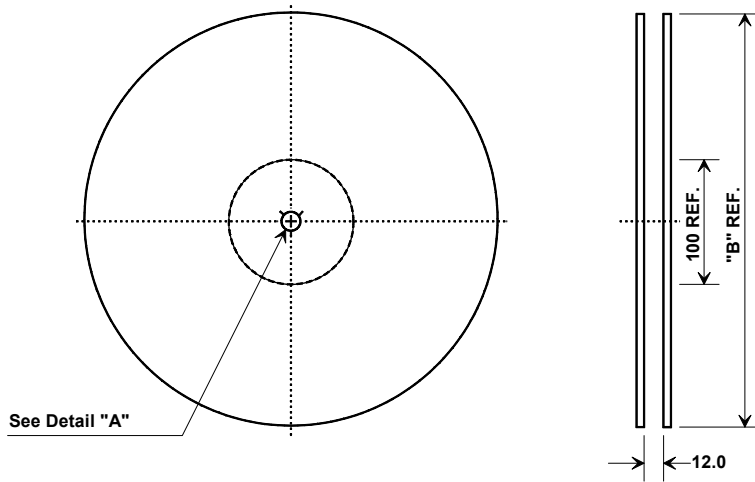
**TOP VIEW**



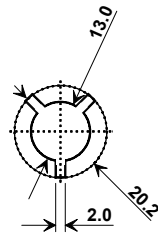
**BOTTOM VIEW**



## Tape and Reel Specifications



"B"		Quantity Per Reel
Inches	millimeters	
7	178	500
13	330	3000



## COMPONENT ORIENTATION and DIMENSIONS

Carrier Tape Dimensions	
Ao	3.35 mm
Bo	3.35 mm
Ko	1.40 mm
Pitch	8.0 mm
W	12.0 mm

